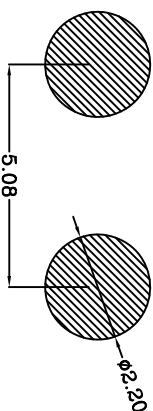
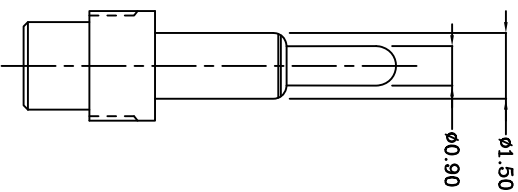
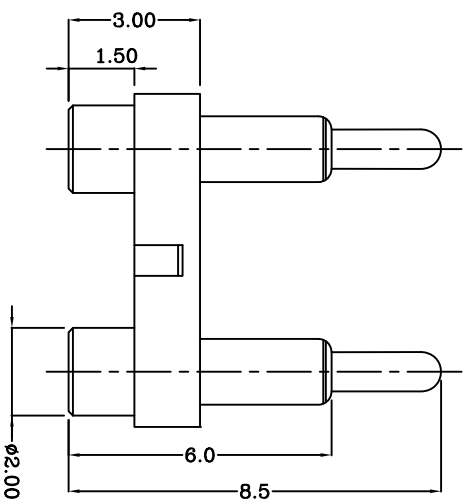
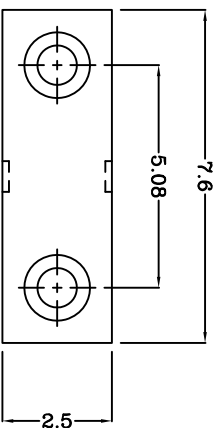


DWG NO.
C-100271



Recommended solder paste thickness is 0.10 mm

TOP-LINK

Notes:
1 Material, Housing: PA 4.6 (30% Glass Filled)

Color Black. (UL94V-0)

Contact: Brass

2 Mechanical demands:

Plating plunger: 0.4 μ m Au over 1.4 μ m Ni
Plating body: 0.1 μ m Au over 1.4 μ m Ni.
Force is 125 $\pm$ 30gf at 1.0 mm stroke.

	NEW	2008/01/05
LTR	REVISION RECORD	APVD DATE

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED				MATL		HT TR		FIN		
0	= ±-	DVN		APVD	Top-Link Electronics Top-Link Electronics Ltd.					
0.0	= ±0.15	Qln		Lansing						
0.00	= ±0.10	CHK		REL						
0.000	= ±	Jlm								
ANGLE: ±1°										
SURF TEXTURE: 32/ ✓				NAME BATTERY CONNECTOR 2 POS.						
REMOVE BURRS, BREAK SHARP EDGES, R0.05 MAX				PGC-1-5-8-5-R-2P-5.08PH						
DO NOT SCALE PRINT				SCALE	1:1	A4	DWG NO.	C-100271	SHEET 1 OF 1	REV A

100271-2
PART NUMBER